

TOSHIBA CMOS Linear Integrated Circuit Silicon Monolithic

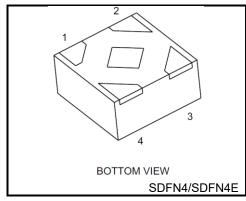
TCR2LN series

Ultra low quiescent current 200 mA CMOS Low Dropout Regulator in ultra small package

The TCR2LN series are CMOS general purpose single output voltage regulators with an on/off control input, featuring ultra low quiescent bias current and low dropout voltage.

These voltage regulators are available in fixed output voltages between 0.8 V and 3.6 V and capable of driving up to 200 mA. They feature overcurrent protection and auto-discharge option.

The TCR2LN series is offered in the ultra small plastic mold package SDFN4/SDFN4E (0.8 mm x 0.8 mm x 0.38 mm) and has a low dropout voltage of 250 mV (2.5 V output, I_{OUT} = 150 mA). As small ceramic input and output capacitors 0.1 μF can be used with the TCR2LN series, these devices are ideal for portable applications that require high-density board assembly such as cellular phones.



Weight: 0.6 mg (typ.)

Features

- Low quiescent bias current ($I_B = 2 \mu A \text{ (max)}$ at $I_{OUT} = 0 \text{ mA}$, $T_j = -40 \text{ to } 85 \text{ °C}$)
- Low dropout voltage
 - V_{DO} = 250 mV (typ.) at 2.5 V-output, I_{OUT} = 150 mA
- Wide range output voltage line up (V_{OUT} = 0.8 to 3.6 V)
- High V_{OUT} accuracy $\pm 1.0 \%$ (1.8 $V \le V_{OUT}$)
- Overcurrent protection
- Auto-discharge
- Pull down connection between CONTROL and GND
- Ceramic capacitors can be used ($C_{IN} = 0.1 \mu F$, $C_{OUT} = 0.1 \mu F$)
- Ultra small package SDFN4 (0.8 mm x 0.8 mm x 0.38 mm)

Start of commercial production 2014-08



Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Input voltage	VIN	6.0	V
Control voltage	Vст	-0.3 to 6.0	V
Output voltage	Vout	-0.3 to V _{IN} + 0.3	V
Output current	lout	200	mA
Power dissipation	PD	300 (Note1)	mW
Operating temperature range	Topr	−40 to 85	°C
Junction temperature	Tj	150	°C
Storage temperature range	T _{stg}	−55 to 150	°C

Note:

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

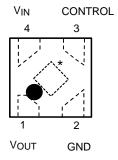
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note1: Rating at mounting on a board

Glass epoxy (FR4) board dimension: 40 mm x 40 mm (both sides of board), t = 1.6 mm Metal pattern ratio: a surface approximately 50 %, the reverse side approximately 50 %

Through hole hall: diameter 0.5 mm x 24

Pin Assignment (top view)



*Center electrode should be connected to GND or Open



List of Products Number, Output voltage and Marking

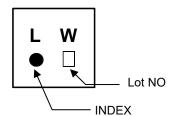
Output Auto discharge type

Product No.	Output voltage(V)	Marking	Product No.	Output voltage(V)	Marking
TCR2LN08	0.8	L8	TCR2LN19	1.9	LF
TCR2LN085	0.85	KS	TCR2LN20	2.0	LG
TCR2LN09	0.9	L9	TCR2LN21	2.1	LH
TCR2LN095	0.95	KT	TCR2LN25	2.5	LM
TCR2LN10	1.0	LJ	TCR2LN27	2.7	LO
TCR2LN105	1.05	LU	TCR2LN28	2.8	LP
TCR2LN11	1.1	L2	TCR2LN285	2.85	L7
TCR2LN115	1.15	LC	TCR2LN30	3.0	LS
TCR2LN12	1.2	L3	TCR2LN31	3.1	LT
TCR2LN13	1.3	L4	TCR2LN32	3.2	LV
TCR2LN15	1.5	LA	TCR2LN33	3.3	LW
TCR2LN18	1.8	LE	TCR2LN36	3.6	LZ

^{*} Please contact local Toshiba representative if you are interested in product that output voltage is not in the list.

Top Marking

Example: TCR2LN33 (3.3 V output)





Electrical Characteristics

(Unless otherwise specified,

Vin = Vout+1 V (Vout > 1.5 V), Vin = 2.5 V (Vout \leq 1.5 V), lout = 50 mA, Cin = 0.1 μ F, Cout = 0.1 μ F)

Observatoristics	O made al	ymbol Test Condition		T _j = 25°C			T _j = -40 to 85°C		11.2
Characteristics	Symbol			Min	Тур.	Max	Min	Max	Unit
Output voltage Vout	\/a=	IOUT = 50 mA (Note 2)	Vout < 1.8 V	-18	_	+18	_	_	mV
	VOUT		1.8V ≤ V _{OUT}	-1.0	_	+1.0	_	_	%
Input voltage	VIN	I _{OUT} = 1 mA		1.5	_	5.5	1.5	5.5	V
Line regulation	Reg·line	$V_{OUT} + 0.5 \text{ V} \le V_{IN} \le 5.5 \text{ V},$ $I_{OUT} = 1 \text{ mA}$		_	1	15	_	_	mV
Load regulation	Reg·load	1 mA ≤ I _{OUT} ≤ 150 mA		_	15	30	_	_	mV
Quiescent current	ΙΒ	I _{OUT} = 0 mA (Note 3)		_	1.0	_	_	2.0	μА
Stand-by current	IB (OFF)	VCT = 0 V		_	0.1	_	_	1.0	μА
Control pull down current	ICT	_		_	0.1	_	_	_	μΑ
Dropout voltage	V _{DO}	I _{OUT} = 150 mA	V _{OUT} = 1.8 V	_	350	_	_	600	mV
	VDO	1001 = 150 IIIA	Vout = 3.0 V	_	200	_	_	280	% V mV mV μA μA
Temperature coefficient	T _C VO	-40°C ≤ T _{opr} ≤ 85°C		_	75	_	_	_	ppm/°C
Control voltage (ON)	VCT (ON)	_		1.0	_	5.5	1.0	5.5	V
Control voltage (OFF)	VCT (OFF)	_		0	_	0.4	0	0.4	V
Discharge on resistance	R _{SD}	_		_	20	_	_	_	Ω

Note 2: Stable state with fixed I_{OUT} condition Note 3: Except Control pull down current

Dropout voltage

(IOUT = 150 mA, CIN = 0.1 μ F, COUT = 0.1 μ F, T $_j$ = 25°C)

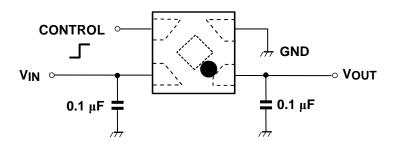
Output voltages	Symbol	Min	Тур.	Max(Note 4)	Unit
0.8 V ≤ V _{OUT} < 0.9 V		_	1000	1560	
0.9 V ≤ V _{OUT} < 1.0 V		_	920	1460	
1.0 V ≤ V _{OUT} < 1.1 V		_	840	1380	
1.1 V ≤ V _{OUT} < 1.2 V		_	760	1280	
1.2 V ≤ V _{OUT} < 1.3 V		_	680	1230	
1.3 V ≤ V _{OUT} < 1.6 V	VDO	_	600	1110	mV
1.6 V ≤ V _{OUT} < 1.8 V		_	450	840	
1.8 V ≤ V _{OUT} < 2.0 V		_	350	600	
2.0 V ≤ V _{OUT} < 2.5 V		_	300	540	
2.5 V ≤ V _{OUT} < 3.0 V		_	250	360	
3.0 V ≤ V _{OUT} ≤ 3.6 V		_	200	280	

Note 4: $T_j = -40 \text{ to } 85^{\circ}\text{C}$



Application Note

1. Example of Application Circuit



CONTROL voltage	Output voltage
HIGH	ON
LOW	OFF
OPEN	OFF

The figure above shows the example of configuration for using a Low dropout regulator. Insert a capacitor at V_{OUT} and V_{IN} pins for stable input/output operation. (Ceramic capacitors can be used.)

2. Power Dissipation

Board mounted power dissipation ratings are available in the Absolute Maximum Ratings table. Power dissipation is measured on the board condition shown below.

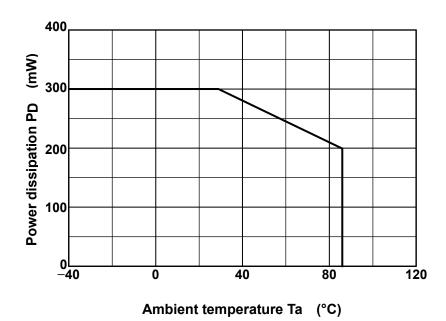
[The Board Condition]

Board material: Glass epoxy(FR4)

Board dimension: 40 mm x 40 mm (both sides of board), t = 1.6 mm

Metal pattern ratio: a surface approximately 50 %, the reverse side approximately 50 %

Through hole: diameter 0.5 mm x 24





Attention in Use

Output Capacitors

Ceramic capacitors can be used for these devices. However, because of the type of the capacitors, there might be unexpected thermal features. Please consider application condition for selecting capacitors. And Toshiba recommends the ESR of ceramic capacitor is under 10 Ω .

Mounting

The long distance between IC and output capacitor might affect phase compensation by impedance in wire and inductor. For stable power supply, output capacitor need to mount near IC as much as possible. Also V_{IN} and GND pattern need to be large and make the wire impedance small as possible.

Permissible Loss

Please have enough design patterns for expected maximum permissible loss. And under consideration of ambient temperature, input voltage, output current etc., we recommend proper dissipation ratings for maximum permissible loss; in general maximum dissipation rating is 70 to 80 %.

Overcurrent Protection

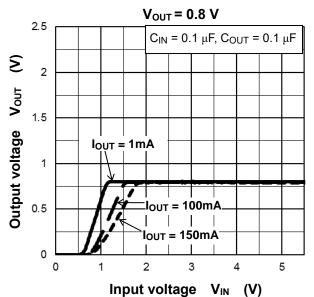
Overcurrent protection is designed in these products, but this does not assure for the suppression of uprising device operation. If output pins and GND pins are shorted out, these products might break down.

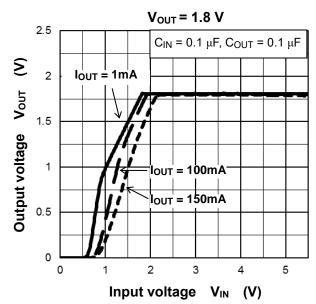
In use of these products, please read through and understand dissipation idea for absolute maximum ratings from the above mention or our 'Semiconductor Reliability Handbook'. Then use these products under absolute maximum ratings in any condition. Furthermore, Toshiba recommends inserting failsafe system into the design.

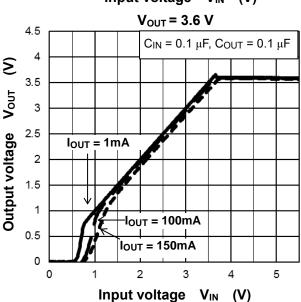


Representative Typical Characteristics

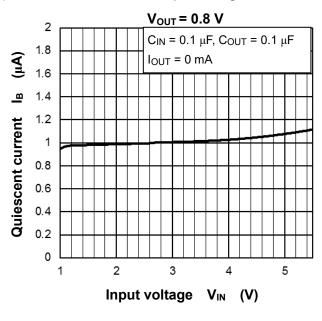
1) Output voltage vs. Input voltage

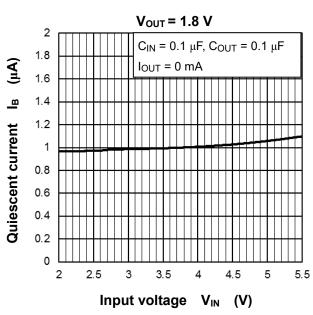




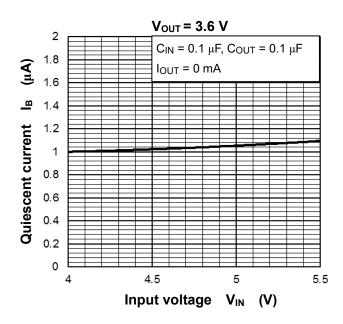


2) Quiescent current vs. Input voltage

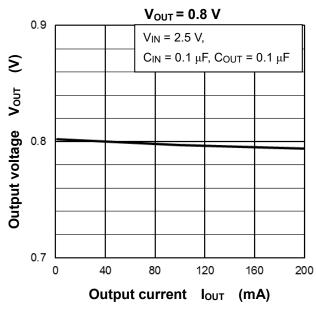


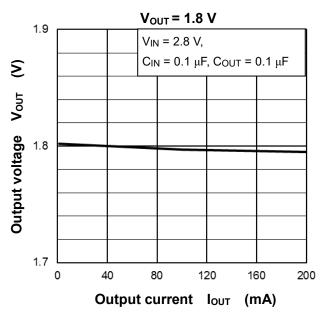


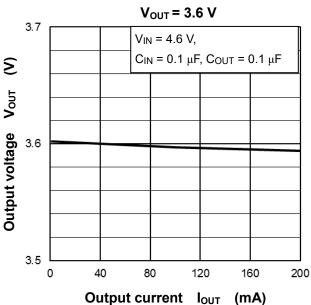




3) Output voltage vs. Output current

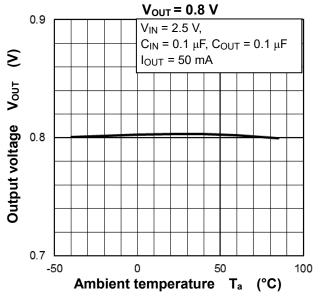


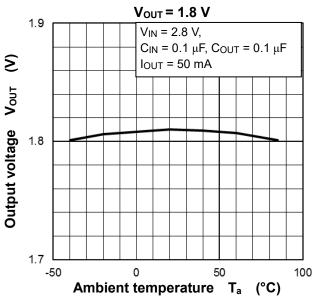


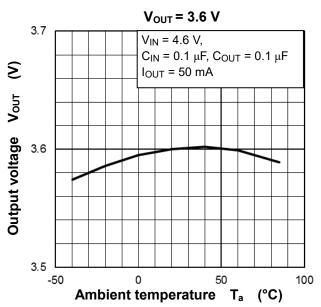




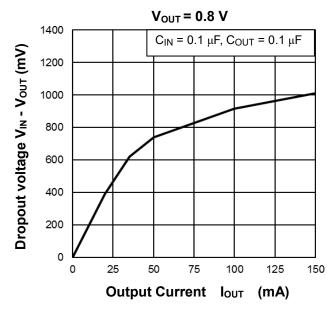
4) Output voltage vs. Ambient temperature

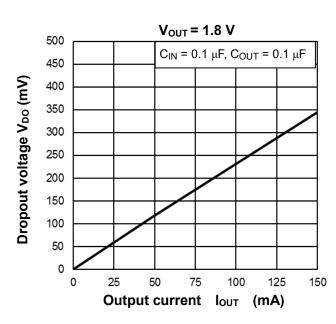




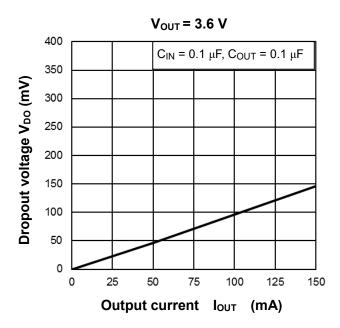


5) Dropout voltage vs. Output current

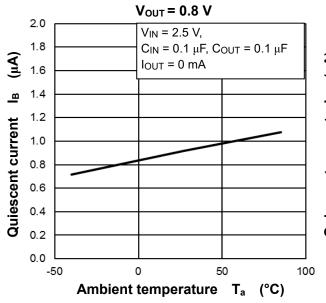


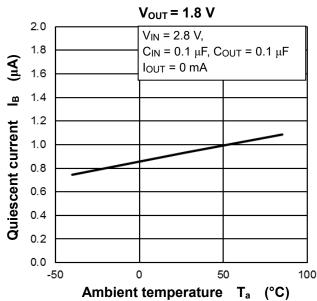


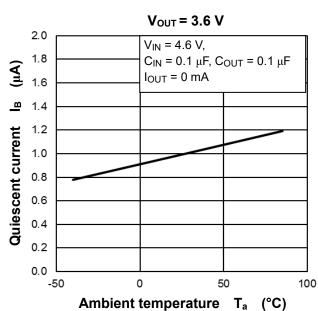




6) Quiescent current vs. Ambient temperature



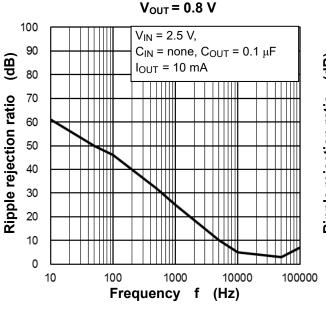


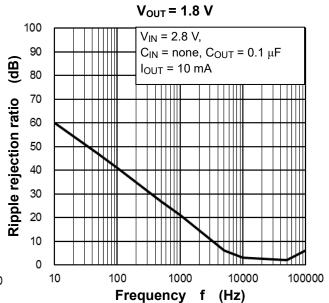


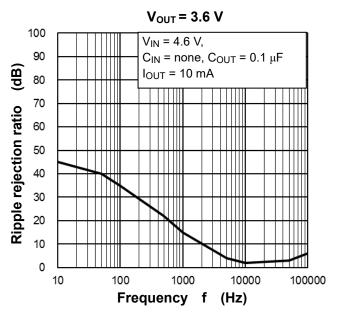
10



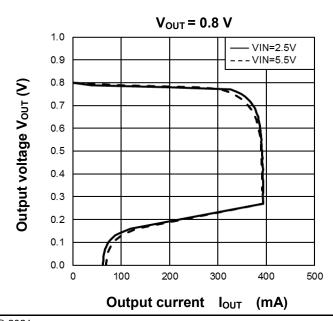
7) Ripple rejection ratio vs. Frequency

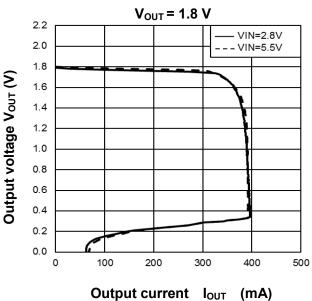




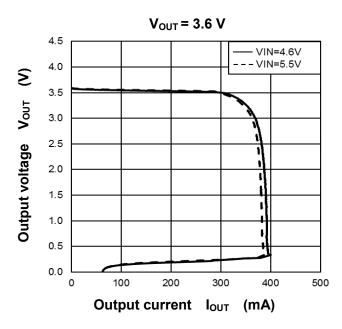


8) Output voltage vs. Output current

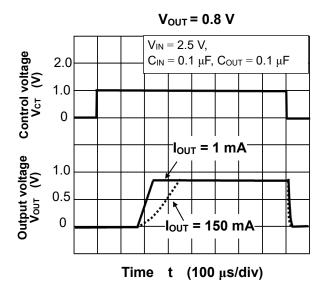


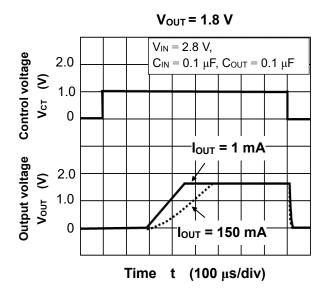


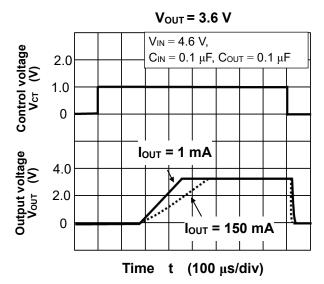




9) Control Transient vs. Response

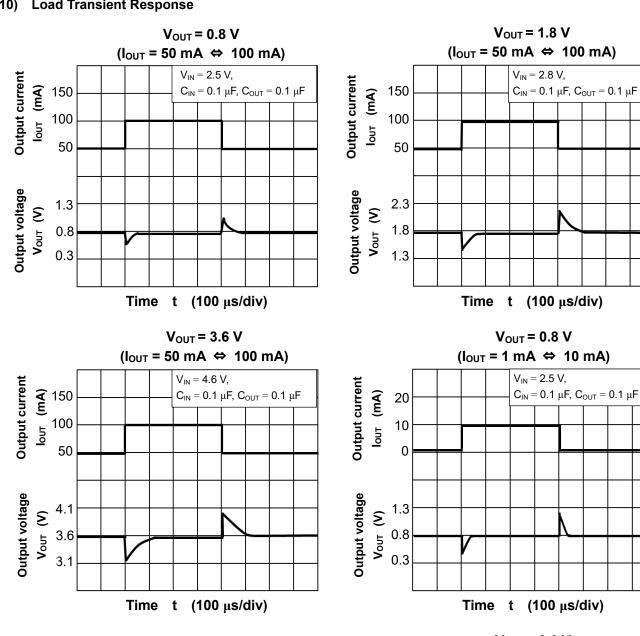


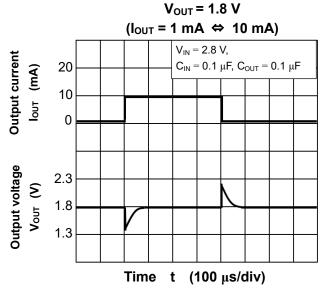


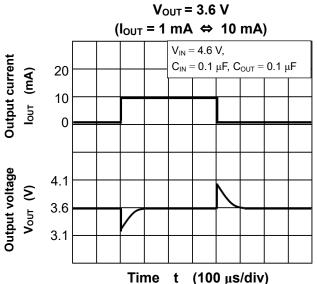




10) Load Transient Response



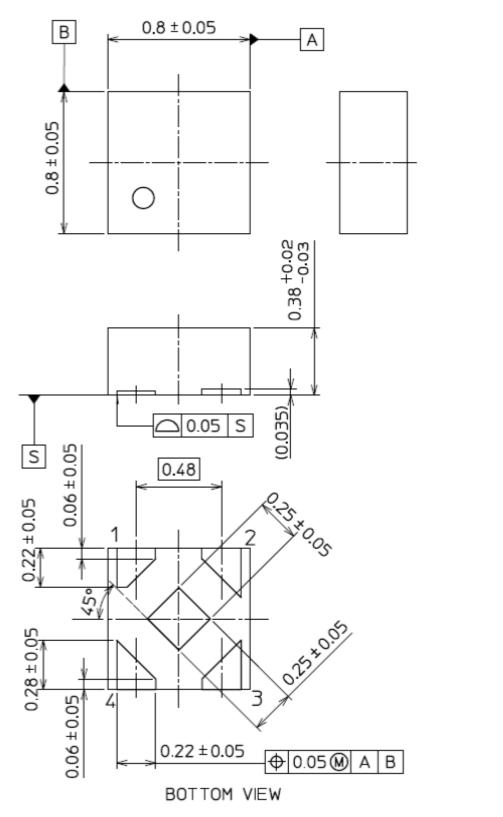






Package Dimensions

SDFN4 Unit: mm



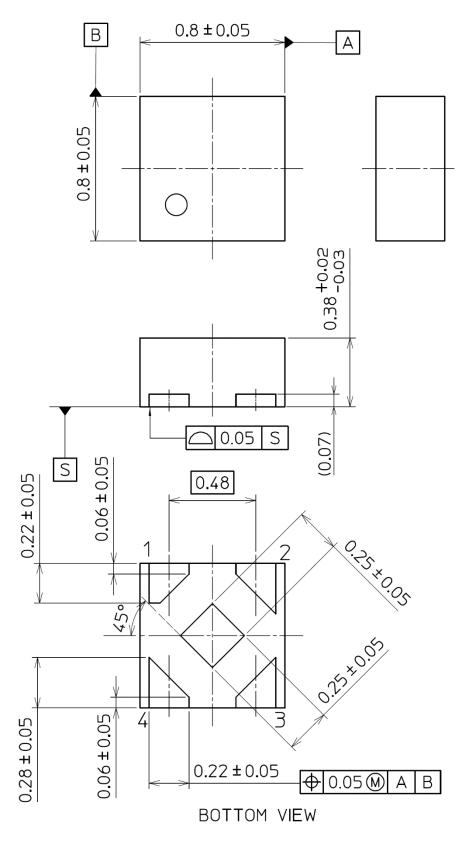
0.04 mm (typ.) unevenness exists along the edges of the back electrode to increase shear after soldering.

Weight: 0.6 mg (typ.)



Package Dimensions

SDFN4E Unit: mm



Weight: 0.6 mg (typ.)



RESTRICTIONS ON PRODUCT USE

Toshiba Corporation and its subsidiaries and affiliates are collectively referred to as "TOSHIBA". Hardware, software and systems described in this document are collectively referred to as "Product".

- TOSHIBA reserves the right to make changes to the information in this document and related Product without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.
- PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE EXTRAORDINARILY
 HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH MAY CAUSE LOSS OF
 HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT ("UNINTENDED USE"). Except for
 specific applications as expressly stated in this document, Unintended Use includes, without limitation, equipment used in nuclear facilities,
 equipment used in the aerospace industry, lifesaving and/or life supporting medical equipment, equipment used for automobiles, trains, ships
 and other transportation, traffic signaling equipment, equipment used to control combustions or explosions, safety devices, elevators and
 escalators, and devices related to power plant. IF YOU USE PRODUCT FOR UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR
 PRODUCT. For details, please contact your TOSHIBA sales representative or contact us via our website.
- · Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any
 infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any
 intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE FOR
 PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY WHATSOEVER,
 INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR LOSS, INCLUDING
 WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND LOSS OF DATA, AND (2)
 DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO SALE, USE OF PRODUCT, OR
 INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE,
 ACCURACY OF INFORMATION, OR NONINFRINGEMENT.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. Please
 use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without
 limitation, the EU RoHS Directive. TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES OCCURRING AS A RESULT OF
 NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.

https://toshiba.semicon-storage.com/

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for LDO Voltage Regulators category:

Click to view products by Toshiba manufacturer:

Other Similar products are found below:

AP7363-SP-13 L79M05TL-E PT7M8202B12TA5EX TCR3DF185,LM(CT TCR3DF24,LM(CT TCR3DF285,LM(CT TCR3DF31,LM(CT TCR3DF31,LM(CT TCR3DF45,LM(CT MP2013GQ-33-Z 059985X NCP4687DH15T1G 701326R TCR2EN28,LF(S NCV8170AXV250T2G TCR3DF27,LM(CT TCR3DF19,LM(CT TCR3DF125,LM(CT TCR2EN18,LF(S AP2112R5A-3.3TRG1 AP7315-25W5-7 IFX30081LDVGRNXUMA1 AP2113KTR-G1 AP2111H-1.2TRG1 ZLDO1117QK50TC AZ1117IH-1.8TRG1 AZ1117ID-ADJTRG1 TCR3DG12,LF MIC5514-3.3YMT-T5 MIC5512-1.2YMT-T5 MIC5317-2.8YM5-T5 SCD7912BTG NCP154MX180270TAG SCD33269T-5.0G NCV8170BMX330TCG NCV8170AMX120TCG NCP706ABMX300TAG NCP153MX330180TCG NCP114BMX075TCG MC33269T-3.5G CAT6243-ADJCMT5T TCR3DG33,LF AP2127N-1.0TRG1 TCR4DG35,LF LT1117CST-3.3 LT1117CST-5 TAR5S15U(TE85L,F) TAR5S18U(TE85L,F) TCR3UG19A,LF TCR4DG105,LF NCV8170AMX360TCG